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20-bit dual supply translating transceiver with configurable voltage translation; 3-state

Rev. 7 — 8 March 2012

Product data sheet

1. General description

The 74AVC20T245 is a 20-bit, dual supply transceiver that enables bi-directional voltage level translation. The device can be used as two 10-bit transceivers or as a single 20-bit transceiver. It features four 10-bit input-output ports (1An, 1Bn and 2An, 2Bn), two output enable inputs ($n\overline{OE}$), two direction inputs (nDIR) and dual supplies ($V_{CC(A)}$ and $V_{CC(B)}$). $V_{CC(A)}$ and $V_{CC(B)}$ can be independently supplied at any voltage between 0.8 V and 3.6 V making the device suitable for bi-directional voltage level translation between any of the low voltage nodes: 0.8 V, 1.2 V, 1.5 V, 1.8 V, 2.5 V and 3.3 V. The 1An and 2An ports, $n\overline{OE}$ and nDIR are referenced to $V_{CC(A)}$, the 1Bn and 2Bn ports are referenced to $V_{CC(B)}$. A HIGH on a 1DIR allows transmission from 1An to 1Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 1An to 7Bn and a LOW on 1DIR allows transmission from 7Bn and 7Bn and

The device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing any damaging backflow current through the device when it is powered down. In suspend mode when either V_{CC(A)} or V_{CC(B)} are at GND level, all output ports will assume a high impedance OFF-state.

2. Features and benefits

- Wide supply voltage range:
 - ◆ V_{CC(A)}: 0.8 V to 3.6 V
 - V_{CC(B)}: 0.8 V to 3.6 V
- Complies with JEDEC standards:
 - JESD8-12 (0.8 V to 1.3 V)
 - JESD8-11 (0.9 V to 1.65 V)
 - ◆ JESD8-7 (1.2 V to 1.95 V)
 - JESD8-5 (1.8 V to 2.7 V)
 - JESD8-B (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F Class 3B exceeds 8000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101C exceeds 1000 V
- Maximum data rates:
 - ◆ 380 Mbit/s (≥ 1.8 V to 3.3 V translation)
 - ◆ 260 Mbit/s (≥ 1.1 V to 3.3 V translation)
 - 260 Mbit/s (\geq 1.1 V to 2.5 V translation)
 - ◆ 210 Mbit/s (≥ 1.1 V to 1.8 V translation)



20-bit dual supply translating transceiver; 3-state

- ◆ 120 Mbit/s (≥ 1.1 V to 1.5 V translation)
- ◆ 100 Mbit/s (≥ 1.1 V to 1.2 V translation)
- Suspend mode
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

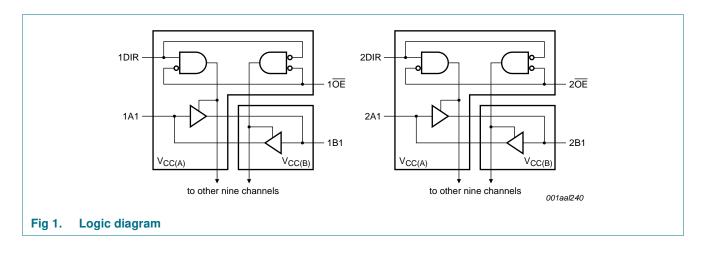
3. Ordering information

Table 1. Ordering information

Type number	Package	ge					
	Temperature range	Name	Description	Version			
74AVC20T245DGG	–40 °C to +125 °C	TSSOP56	plastic thin shrink small outline package; 56 leads; body width 6.1 mm	SOT364-1			
74AVC20T245DGV	–40 °C to +125 °C	TSSOP56 ^[1]	plastic thin shrink small outline package; 56 leads; body width 4.4 mm	SOT481-2			
74AVC20T245BX	–40 °C to +125 °C	HXQFN60	plastic compatible thermal enhanced extremely thin quad flat package; no leads; 60 terminals; body $4 \times 6 \times 0.5$ mm	SOT1134-2			

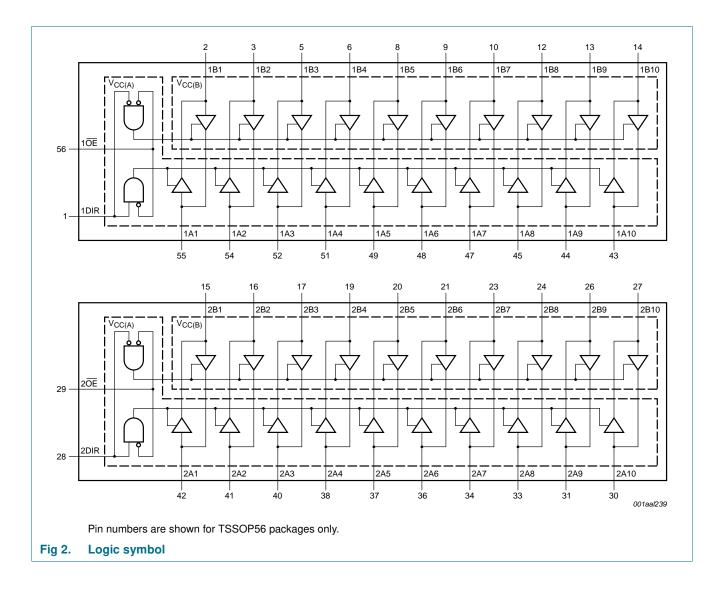
[1] Also known as TVSOP56.

4. Functional diagram



74AVC20T245

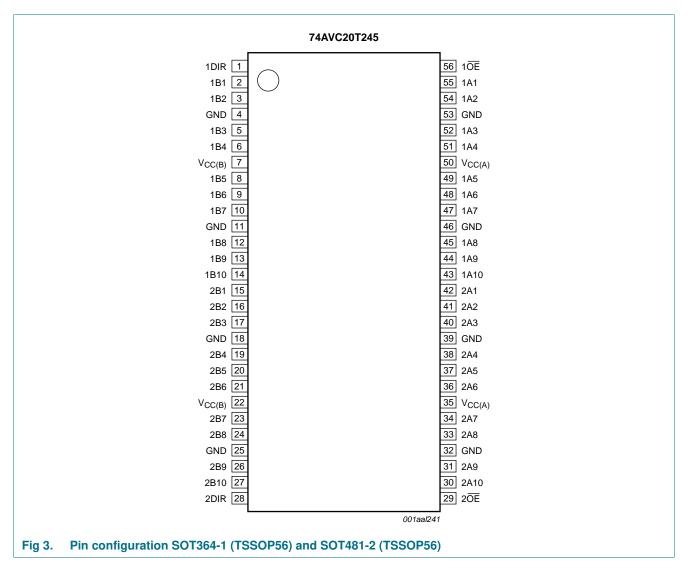
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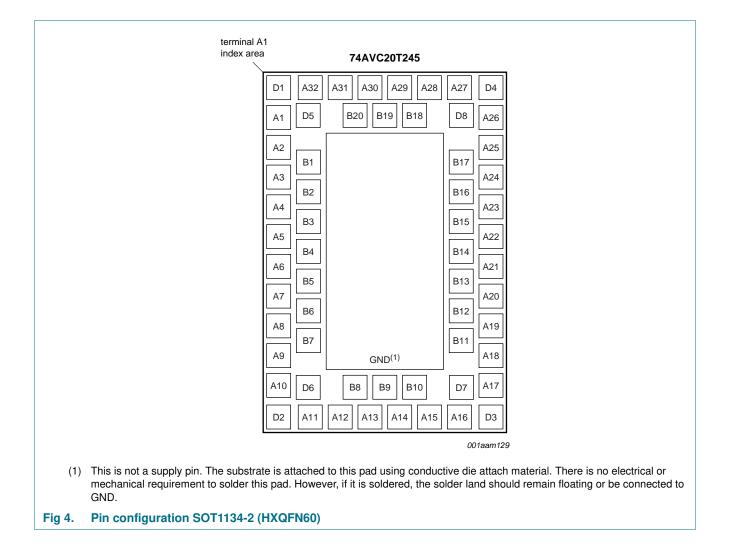
5. Pinning information

5.1 Pinning



74AVC20T245

20-bit dual supply translating transceiver; 3-state



20-bit dual supply translating transceiver; 3-state

5.2 Pin description

Symbol	Pin		Description
	SOT364-1 and SOT481-2	SOT1134-2	_
1DIR, 2DIR	1, 28	A30, A13	direction control
1B1 to 1B10	2, 3, 5, 6, 8, 9, 10, 12, 13, 14	B20, A31, D5, D1, B1, A2, B2, A4, B3, A5	data input or output
2B1 to 2B10	15, 16, 17, 19, 20, 21, 23, 24, 26, 27	A6, B5, A7, B6, A9, B7, D2, D6, A12, B8	data input or output
GND ^[1]	4, 11, 18, 25, 32, 39, 46, 53	A32, A3, A8, A11, A16, A19, A24, A27	ground (0 V)
V _{CC(B)}	7, 22	A1, A10	supply voltage B (nBn inputs are referenced to $V_{CC(B)}) \label{eq:constraint}$
1 <u>0E</u> , 2 <u>0E</u>	56, 29	A29, A14	output enable input (active LOW)
1A1 to 1A10	55, 54, 52, 51, 49, 48, 47, 45, 44, 43	B18, A28, D8, D4, B17, A25, B16, A23, B15, A22	data input or output
2A1 to 2A10	42, 41, 40, 38, 37, 36, 34, 33, 31, 30	A21, B13, A20, B12, A18, B11, D3, D7, A15, B10	data input or output
V _{CC(A)}	35, 50	A17, A26	supply voltage A (nAn, n $\overline{\text{OE}}$ and nDIR inputs are referenced to $V_{\text{CC}(A)})$
n.c.	-	B4, B9, B14, B19	not connected

[1] All GND pins must be connected to ground (0 V).

6. Functional description

Table 3.Function table[1]

Supply voltage	Input		Input/output ^[2]	
V _{CC(A)} , V _{CC(B)}	nOE ^[3]	nDIR ^[3]	nAn ^[3]	nBn <mark>3</mark>
0.8 V to 3.6 V	L	L	nAn = nBn	input
0.8 V to 3.6 V	L	Н	input	nBn = nAn
0.8 V to 3.6 V	Н	Х	Z	Z
GND ^[2]	Х	Х	Z	Z

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

[2] If at least one of $V_{CC(A)}$ or $V_{CC(B)}$ is at GND level, the device goes into suspend mode.

[3] The nAn, nDIR and nOE input circuit is referenced to V_{CC(A)}; The nBn input circuit is referenced to V_{CC(B)}.

20-bit dual supply translating transceiver; 3-state

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC(A)}	supply voltage A		-0.5	+4.6	V
V _{CC(B)}	supply voltage B		-0.5	+4.6	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	Active mode	<u>[1][2][3]</u> _0.5	$V_{CCO} + 0.5$	V
		Suspend or 3-state mode	<u>[1]</u> –0.5	+4.6	V
lo	output current	$V_{O} = 0 V$ to V_{CCO}	[2] _	±50	mA
I _{CC}	supply current	I _{CC(A)} or I _{CC(B)}	-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$			
		TSSOP56 package	<u>[4]</u> _	600	mW
		HXQFN60 package	<u>[5]</u> _	1000	mW

[1] The minimum input and minimum output voltage ratings may be exceeded if the input and output clamping current ratings are observed.

 $\label{eq:VCCO} \mbox{ is the supply voltage associated with the output port.}$

[3] V_{CCO} + 0.5 V should not exceed 4.6 V.

[4] Above 55 °C the value of P_{tot} derates linearly with 8.0 mW/K.

[5] Above 70 °C the value of Ptot derates linearly with 1.8 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC(A)}	supply voltage A		0.8	3.6	V
V _{CC(B)}	supply voltage B		0.8	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	Active mode	<u>[1]</u> 0	V _{CCO}	V
		Suspend or 3-state mode	0	3.6	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CCI} = 0.8 V \text{ to } 3.6 V$	[2] _	5	ns/V

[1] V_{CCO} is the supply voltage associated with the output port.

[2] V_{CCI} is the supply voltage associated with the input port.

20-bit dual supply translating transceiver; 3-state

9. Static characteristics

Table 6. Typical static characteristics at $T_{amb} = 25 \ ^{\circ}C^{[1][2]}$

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{OH}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = -1.5 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 0.8 \text{ V}$	-	0.69	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_O = 1.5 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 0.8 \text{ V}$	-	0.07	-	V
l _l	input leakage current	nDIR, n $\overline{\text{OE}}$ input; V _I = 0 V or 3.6 V; V _{CC(A)} = V _{CC(B)} = 0.8 V to 3.6 V	-	±0.025	±0.25	μ A
I _{OZ} (OFF-state output current	A or B port; $V_O = 0$ V or V_{CCO} ; $V_{CC(A)} = V_{CC(B)} = 3.6$ V	<u>[3]</u> _	±0.5	±2.5	μ A
		suspend mode A port; V _O = 0 V or V _{CCO} ; V _{CC(A)} = 3.6 V; V _{CC(B)} = 0 V	<u>[3]</u>	±0.5	±2.5	μ A
		suspend mode B port; V_O = 0 V or V_{CCO}; V_{CC(A)} = 0 V; V_{CC(B)} = 3.6 V	<u>[3]</u> _	±0.5	±2.5	μ A
I _{OFF}	power-off leakage current	A port; V _I or V _O = 0 V to 3.6 V; V _{CC(A)} = 0 V; V _{CC(B)} = 0.8 V to 3.6 V	-	±0.1	±1	μ A
		B port; V _I or V _O = 0 V to 3.6 V; V _{CC(B)} = 0 V; V _{CC(A)} = 0.8 V to 3.6 V	-	±0.1	±1	μA
Cı	input capacitance	nDIR, n \overline{OE} input; V _I = 0 V or 3.3 V; V _{CC(A)} = V _{CC(B)} = 3.3 V	-	2.0	-	pF
C _{I/O}	input/output capacitance	A and B port; $V_O = 3.3$ V or 0 V; $V_{CC(A)} = V_{CC(B)} = 3.3$ V	-	4.0	-	pF

[1] V_{CCO} is the supply voltage associated with the output port.

[2] V_{CCI} is the supply voltage associated with the data input port.

[3] For I/O ports, the parameter I_{OZ} includes the input leakage current.

Table 7. Static characteristics [1][2]

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	–40 °C to	+85 °C	–40 °C to +125 °C		Unit
			Min	Max	Min	Max	
	HIGH-level	data input					
	input voltage	V _{CCI} = 0.8 V	0.70V _{CCI}	-	0.70V _{CCI}	-	V
		V _{CCI} = 1.1 V to 1.95 V	0.65V _{CCI}	-	$0.65V_{CCI}$	-	V
		$V_{CCI} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$	1.6	-	1.6	-	V
		$V_{CCI} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2	-	2	-	V
		nDIR, nOE input					
		$V_{CC(A)} = 0.8 V$	0.70V _{CC(A)}	-	0.70V _{CC(A)}	-	V
		$V_{CC(A)} = 1.1 \text{ V to } 1.95 \text{ V}$	0.65V _{CC(A)}	-	$0.65V_{CC(A)}$	-	V
		$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$	1.6	-	1.6	-	V
		$V_{CC(A)} = 3.0 \text{ V to } 3.6 \text{ V}$	2	-	2	-	V

74AVC20T245

20-bit dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions	–40 °C t	o +85 °C	–40 °C to	o +125 ℃	Uni
			Min	Max	Min	Max	-
/ _{IL}	LOW-level	data input					
	input voltage	$V_{CCI} = 0.8 V$	-	0.30V _{CCI}	-	0.30V _{CCI}	V
		V _{CCI} = 1.1 V to 1.95 V	-	0.35V _{CCI}	-	$0.35V_{CCI}$	V
		$V_{CCI} = 2.3 \text{ V to } 2.7 \text{ V}$	-	0.7	-	0.7	V
		$V_{CCI} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	0.8	-	0.8	V
		nDIR, nOE input					
		$V_{CC(A)} = 0.8 V$	-	0.30V _{CC(A)}	-	0.30V _{CC(A)}	V
		V _{CC(A)} = 1.1 V to 1.95 V	-	0.35V _{CC(A)}	-	0.35V _{CC(A)}	V
		$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$	-	0.7	-	0.7	V
		V _{CC(A)} = 3.0 V to 3.6 V	-	0.8	-	0.8	V
он	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$					
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC(A)} = V_{CC(B)} = 0.8 \ V \text{ to } 3.6 \ V$	$V_{CCO} - 0.1$	-	$V_{\text{CCO}}-0.1$	-	V
		$\label{eq:loss} \begin{array}{l} I_{O}=-3 \text{ mA};\\ V_{CC(A)}=V_{CC(B)}=1.1 \text{ V} \end{array}$	0.85	-	0.85	-	V
		$ I_O = -6 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 1.4 \text{ V} $	1.05	-	1.05	-	V
		$I_{O} = -8 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 1.65 \text{ V}$	1.2	-	1.2	-	V
		$\label{eq:loss} \begin{array}{l} I_{O}=-9 \text{ mA};\\ V_{CC(A)}=V_{CC(B)}=2.3 \text{ V} \end{array}$	1.75	-	1.75	-	V
		$I_{O} = -12 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 3.0 \text{ V}$	2.3	-	2.3	-	V
OL	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$					
	output voltage	$ I_O = 100 \ \mu \text{A}; \\ V_{CC(\text{A})} = V_{CC(\text{B})} = 0.8 \ \text{V to } 3.6 \ \text{V} $	-	0.1	-	0.1	V
		$I_{O} = 3 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 1.1 \text{ V}$	-	0.25	-	0.25	V
		$I_{O} = 6 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 1.4 \text{ V}$	-	0.35	-	0.35	V
		$I_{O} = 8 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 1.65 \text{ V}$	-	0.45	-	0.45	V
		$I_{O} = 9 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 2.3 \text{ V}$	-	0.55	-	0.55	V
		$\label{eq:loss} \begin{array}{l} I_{O} = 12 \text{ mA}; \\ V_{CC(A)} = V_{CC(B)} = 3.0 \text{ V} \end{array}$	-	0.7	-	0.7	V
	input leakage current	$\label{eq:nDIR} \begin{array}{l} n \overline{OE} \text{ input}; \ V_I = 0 \ V \text{ or } 3.6 \ V; \\ V_{CC(A)} = V_{CC(B)} = 0.8 \ V \text{ to } 3.6 \ V \end{array}$	-	±1	-	±5	μA
DZ	OFF-state output current	A or B port; $V_O = 0$ V or V_{CCO} ; $V_{CC(A)} = V_{CC(B)} = 3.6$ V	[3] -	±5	-	±30	μA
		suspend mode A port; $V_O = 0 V \text{ or } V_{CCO}; V_{CC(A)} = 3.6 V;$ $V_{CC(B)} = 0 V$	[3] _	±5	-	±30	μA
		suspend mode B port; $V_O = 0 V \text{ or } V_{CCO}; V_{CC(A)} = 0 V;$ $V_{CC(B)} = 3.6 V$	[3] -	±5	-	±30	μA

Table 7. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

20-bit dual supply translating transceiver; 3-state

Symbol	Parameter	Conditions	–40 °C t	to +85 °C	–40 °C to	o +125 °C	Unit				
			Min	Max	Min	Мах					
I _{OFF}	power-off leakage	A port; V ₁ or V _O = 0 V to 3.6 V; V _{CC(A)} = 0 V; V _{CC(B)} = 0.8 V to 3.6 V	-	±5	-	±30	μA				
	current	$ \begin{array}{l} B \mbox{ port; } V_{1} \mbox{ or } V_{O} = 0 \mbox{ V to } 3.6 \mbox{ V;} \\ V_{CC(B)} = 0 \mbox{ V; } V_{CC(A)} = 0.8 \mbox{ V to } 3.6 \mbox{ V} \end{array} $	-	- ±5 - ±30 μ		μA					
I _{CC}	supply current	A port; $V_I = 0$ V or V_{CCI} ; $I_O = 0$ A									
		$V_{CC(A)} = 0.8 V \text{ to } 3.6 V;$ $V_{CC(B)} = 0.8 V \text{ to } 3.6 V$	-	45	-	190	μA				
		$V_{CC(A)} = 1.1 V \text{ to } 3.6 V;$ $V_{CC(B)} = 1.1 V \text{ to } 3.6 V$	-	35	-	140	μA				
		$V_{CC(A)} = 3.6 \text{ V}; V_{CC(B)} = 0 \text{ V}$	-	35	-	140	μA				
		$V_{CC(A)} = 0 V; V_{CC(B)} = 3.6 V$	-5	-	-20	-	μA				
		B port; $V_I = 0$ V or V_{CCI} ; $I_O = 0$ A									
						$V_{CC(A)} = 0.8 V$ to 3.6 V; $V_{CC(B)} = 0.8 V$ to 3.6 V	-	45	-	190	μA
		$V_{CC(A)} = 1.1 V \text{ to } 3.6 V;$ $V_{CC(B)} = 1.1 V \text{ to } 3.6 V$	-	35	-	140	μA				
		$V_{CC(A)} = 3.6 \text{ V}; V_{CC(B)} = 0 \text{ V}$	-5	-	-20	-	μA				
		$V_{CC(A)} = 0 V; V_{CC(B)} = 3.6 V$	-	35	-	140	μA				
		A plus B port $(I_{CC(A)} + I_{CC(B)});$ $I_O = 0 A; V_I = 0 V \text{ or } V_{CCI};$ $V_{CC(A)} = 0.8 V \text{ to } 3.6 V;$ $V_{CC(B)} = 0.8 V \text{ to } 3.6 V$	-	80	-	270	μΑ				
		A plus B port ($I_{CC(A)} + I_{CC(B)}$); $I_O = 0$ A; $V_I = 0$ V or V_{CCI} ; $V_{CC(A)} = 1.1$ V to 3.6 V; $V_{CC(B)} = 1.1$ V to 3.6 V	-	65	-	220	μA				

Table 7. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

 $\label{eq:VCCO} \mbox{ is the supply voltage associated with the output port.}$

 $\label{eq:VCCI} \ensuremath{\left[2\right]} \quad V_{CCI} \ensuremath{\text{ is the supply voltage associated with the data input port.}$

[3] For I/O ports, the parameter I_{OZ} includes the input leakage current.

Table 8.	Typical total	supply current	$(I_{CC(A)} + I_{CC(B)})$
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V _{CC(A)}	V _{CC(B)}							Unit
	0 V	0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
0 V	0	0.1	0.1	0.1	0.1	0.1	0.1	μA
0.8 V	0.1	0.1	0.1	0.1	0.1	0.3	1.6	μA
1.2 V	0.1	0.1	0.1	0.1	0.1	0.1	0.8	μA
1.5 V	0.1	0.1	0.1	0.1	0.1	0.1	0.4	μA
1.8 V	0.1	0.1	0.1	0.1	0.1	0.1	0.2	μA
2.5 V	0.1	0.3	0.1	0.1	0.1	0.1	0.1	μA
3.3 V	0.1	1.6	0.8	0.4	0.2	0.1	0.1	μA

20-bit dual supply translating transceiver; 3-state

10. Dynamic characteristics

Table 9.Typical power dissipation capacitance at $V_{CC(A)} = V_{CC(B)}$ and $T_{amb} = 25 \ ^{\circ}C \ ^{[1][2]}$ Voltages are referenced to GND (ground = 0 V).

Conditions Symbol Parameter $V_{CC(A)} = V_{CC(B)}$ Unit 0.8 V 1.2 V 1.5 V 1.8 V 2.5 V 3.3 V 0.2 0.2 CPD power dissipation A port: (direction A to B); 0.2 0.2 0.3 0.4 pF capacitance output enabled 0.2 0.2 0.2 A port: (direction A to B); 0.2 0.3 0.4 pF output disabled A port: (direction B to A); 9.5 9.7 9.8 9.9 10.7 11.9 pF output enabled A port: (direction B to A); 0.6 0.6 0.6 0.6 0.7 0.7 pF output disabled B port: (direction A to B); 9.7 9.8 9.9 10.7 11.9 9.5 pF output enabled B port: (direction A to B); 0.6 0.6 0.6 0.6 0.7 0.7 pF output disabled B port: (direction B to A); 0.2 0.2 0.2 0.2 0.3 0.4 pF output enabled B port: (direction B to A); 0.2 0.2 0.2 0.2 0.3 0.4 pF output disabled

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 $f_i = input frequency in MHz;$

f_o = output frequency in MHz;

 $C_L = load capacitance in pF;$

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

[2] $f_i = 10 \text{ MHz}$; $V_I = \text{GND}$ to V_{CC} ; $t_r = t_f = 1 \text{ ns}$; $C_L = 0 \text{ pF}$; $R_L = \infty \Omega$.

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0	D	O						-	
Symbol	Parameter	Conditions	V _{CC(B)}						Unit
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
t _{pd} propagation dela	propagation delay	nAn to nBn	14.4	7.0	6.2	6.0	5.9	6.0	ns
		nBn to nAn	14.4	12.4	12.1	11.9	11.8	11.8	ns
t _{dis}	disable time	nOE to nAn	16.2	16.2	16.2	16.2	16.2	16.2	ns
		nOE to nBn	17.6	10.0	9.0	9.1	8.7	9.3	ns
t _{en}	enable time	nOE to nAn	21.9	21.9	21.9	21.9	21.9	21.9	ns
		nOE to nBn	22.2	11.1	9.8	9.4	9.4	9.6	ns

Table 10. Typical dynamic characteristics at $V_{CC(A)} = 0.8 V$ and $T_{amb} = 25 \ ^{\circ}C$ [1]Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 7; for wave forms see Figure 5 and Figure 6

[1] t_{pd} is the same as t_{PLH} and t_{PHL} ; t_{dis} is the same as t_{PLZ} and t_{PHZ} ; t_{en} is the same as t_{PZL} and t_{PZH} .

Table 11. Typical dynamic characteristics at $V_{CC(B)} = 0.8$ V and $T_{amb} = 25$ °C [1]

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 7; for wave forms see Figure 5 and Figure 6

Symbol	Parameter	Conditions			Vc	C(A)			Unit
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
t _{pd}	t _{pd} propagation delay	nAn to nBn	14.4	12.4	12.1	11.9	11.8	11.8	ns
	nBn to nAn	14.4	7.0	6.2	6.0	5.9	6.0	ns	
t _{dis}	disable time	nOE to nAn	16.2	5.9	4.4	4.2	3.1	3.5	ns
		nOE to nBn	17.6	14.2	13.7	13.6	13.3	13.1	ns
t _{en}	enable time	nOE to nAn	21.9	6.4	4.4	3.5	2.6	2.3	ns
		nOE to nBn	22.2	17.7	17.2	17.0	16.8	16.7	ns

[1] t_{pd} is the same as t_{PLH} and t_{PHL} ; t_{dis} is the same as t_{PLZ} and t_{PHZ} ; t_{en} is the same as t_{PZL} and t_{PZH} .

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Symbol	Parameter	Conditions					Vc	C(B)					Uni
			$1.2 \text{ V} \pm 0.1 \text{ V}$		$1.5 V \pm 0.1 V$		1	0.15 V	$2.5~V\pm0.2~V$		3.3 V :	± 0.3 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
V _{CC(A)} =	1.1 V to 1.3 V												
t _{pd}	propagation	nAn to nBn	0.5	9.4	0.5	7.1	0.5	6.2	0.5	5.2	0.5	5.1	ns
	delay	nBn to nAn	0.5	9.4	0.5	8.9	0.5	8.7	0.5	8.4	0.5	8.2	ns
t _{dis}	disable time	n OE to nAn	2.0	11.9	2.0	11.9	2.0	11.9	2.0	11.9	2.0	11.9	ns
		nOE to nBn	1.5	12.7	1.5	9.8	1.5	9.6	1.0	8.1	1.0	9.0	ns
t _{en}	enable time	nOE to nAn	1.5	15.3	1.5	15.3	1.5	15.3	1.5	15.3	1.5	15.3	ns
		nOE to nBn	1.0	15.6	1.0	11.5	1.0	10.0	0.5	8.4	0.5	8.0	ns
$V_{CC(A)} =$	1.4 V to 1.6 V												
t _{pd}	propagation	nAn to nBn	0.5	8.9	0.5	6.4	0.5	5.4	0.5	4.3	0.5	3.9	ns
	delay	nBn to nAn	0.5	7.1	0.5	6.4	0.5	6.1	0.5	5.8	0.5	5.7	ns
t _{dis}	disable time	nOE to nAn	2.0	9.0	2.0	9.0	2.0	9.0	2.0	9.0	2.0	9.0	ns
		nOE to nBn	1.5	11.7	1.5	9.0	1.5	7.8	1.0	6.4	1.0	6.0	ns
t _{en} enabl	enable time	nOE to nAn	1.5	10.3	1.5	10.3	1.5	10.3	1.5	10.2	1.5	10.2	ns
0.1		nOE to nBn	1.0	14.3	1.0	10.3	1.0	8.4	0.5	6.1	0.5	5.3	ns
$V_{CC(A)} =$	1.65 V to 1.95	V											
	propagation	nAn to nBn	0.5	8.7	0.5	6.1	0.5	5.0	0.5	3.9	0.5	3.5	ns
	delay	nBn to nAn	0.5	6.2	0.5	5.4	0.5	5.0	0.5	4.7	0.5	4.6	ns
t _{dis}	disable time	nOE to nAn	2.0	7.4	2.0	7.4	2.0	7.4	2.0	7.4	2.0	7.4	ns
		nOE to nBn	1.5	11.3	1.5	8.7	1.5	7.4	1.0	5.8	1.0	5.6	ns
t _{en}	enable time	nOE to nAn	1.0	8.1	1.0	8.1	1.0	7.9	1.0	7.9	1.0	7.9	ns
on a		nOE to nBn	0.5	13.8	0.5	10.0	0.5	7.9	0.5	5.7	0.5	4.8	ns
$V_{CC(A)} = $	2.3 V to 2.7 V												
t _{pd}	propagation	nAn to nBn	0.5	8.4	0.5	5.8	0.5	4.7	0.5	3.5	0.5	3.0	ns
pu	delay	nBn to nAn	0.5	5.2	0.5	4.3	0.5	3.9	0.5	3.5	0.5	3.4	ns
t _{dis}	disable time	nOE to nAn	1.1	5.2	1.1	5.2	1.1	5.2	1.1	5.2	1.1	5.2	ns
410		nOE to nBn	1.2	10.8	1.2	8.2	1.2	6.9	1.0	5.3	1.0	5.2	ns
t _{en}	enable time	nOE to nAn	0.5	5.4	0.5	5.4	0.5	5.3	0.5	5.2	0.5	5.2	ns
-611		nOE to nBn	0.5	13.3	0.5	9.6	0.5	7.6	0.5	5.3	0.5	4.3	ns
$V_{CC(A)} = $	3.0 V to 3.6 V												
t _{pd}	propagation	nAn to nBn	0.5	8.2	0.5	5.7	0.5	4.6	0.5	3.4	0.5	2.9	ns
-ha	delay	nBn to nAn	0.5	5.1	0.5	3.9	0.5	3.5	0.5	3.0	0.5	2.9	ns
t _{dis}	disable time	nOE to nAn	0.8	5.0	0.8	5.0	0.8	5.0	0.8	5.0	0.8	5.0	ns
uis		nOE to nBn	1.2	10.5	1.2	8.1	1.2	6.7	1.0	5.1	0.8	5.0	ns
t	enable time	nOE to nAn	0.5	4.4	0.5	4.4	0.5	4.3	0.5	4.2	0.5	4.1	
t _{en}	enable linte	nOE to nAn	1.0	4.4	1.0	4.4 9.6	0.5	4.3 7.5	0.5	4.2 5.1	0.5	4.1	ns

Table 12	Dynamic characteristics for temperature range –40 °C to +85 °C [1]
	Bynamic characteristics for temperature range -+0 0 to +05 0 1
Voltanas a	re referenced to GND (around $= 0.1$); for test circuit see Figure 7; for wave forms see Figure 5 and Fig

[1] t_{pd} is the same as t_{PLH} and t_{PHL} ; t_{dis} is the same as t_{PLZ} and t_{PHZ} ; t_{en} is the same as t_{PZL} and t_{PZH} .

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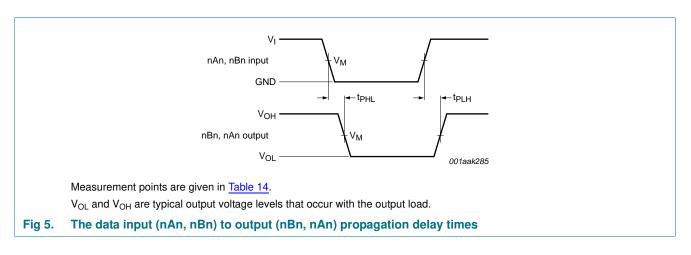
Symbol	Parameter	Conditions	V _{CC(B)}							Unit			
			$1.2 V \pm 0.1 V$		$1.5 V \pm 0.1 V$		$1.8 \text{ V} \pm 0.15 \text{ V}$		$2.5 V \pm 0.2 V$		$3.3 V \pm 0.3 V$		
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	1
$V_{CC(A)} =$	1.1 V to 1.3 V												
t _{pd}	propagation	nAn to nBn	0.5	10.4	0.5	7.9	0.5	6.9	0.5	5.8	0.5	5.7	ns
	delay	nBn to nAn	0.5	10.4	0.5	9.8	0.5	9.6	0.5	9.3	0.5	9.1	ns
t _{dis}	disable time	nOE to nAn	2.0	13.1	2.0	13.1	2.0	13.1	2.0	13.1	2.0	13.1	ns
		nOE to nBn	1.5	14.0	1.5	10.8	1.5	10.6	1.0	9.0	1.0	9.9	ns
t _{en}	enable time	nOE to nAn	1.5	16.9	1.5	16.9	1.5	16.9	1.5	16.9	1.5	16.9	ns
		nOE to nBn	1.0	17.2	1.0	12.7	1.0	11.0	0.5	9.3	0.5	8.8	ns
$V_{CC(A)} =$	1.4 V to 1.6 V												
t _{pd}	propagation	nAn to nBn	0.5	9.8	0.5	7.1	0.5	6.0	0.5	4.8	0.5	4.3	ns
	delay	nBn to nAn	0.5	7.9	0.5	7.1	0.5	6.8	0.5	6.4	0.5	6.3	ns
t _{dis}	disable time	nOE to nAn	2.0	9.9	2.0	9.9	2.0	9.9	2.0	9.9	2.0	9.9	ns
		nOE to nBn	1.5	12.9	1.5	9.9	1.5	8.6	1.0	7.1	1.0	6.6	ns
t _{en}	enable time	nOE to nAn	1.5	11.4	1.5	11.4	1.5	11.4	1.5	11.3	1.5	11.3	ns
		nOE to nBn	1.0	15.8	1.0	11.4	1.0	9.3	0.5	6.8	0.5	5.9	ns
$V_{CC(A)} =$	1.65 V to 1.95	V											
t _{pd}	od propagation delay	nAn to nBn	0.5	9.6	0.5	6.8	0.5	5.5	0.5	4.3	0.5	3.9	ns
		nBn to nAn	0.5	6.9	0.5	6.0	0.5	5.5	0.5	5.2	0.5	5.1	ns
t _{dis}	disable time	nOE to nAn	2.0	8.2	2.0	8.2	2.0	8.2	2.0	8.2	2.0	8.2	ns
		nOE to nBn	1.5	12.5	1.5	9.6	1.5	8.2	1.0	6.4	1.0	6.2	ns
t _{en}	enable time	nOE to nAn	1.0	9.0	1.0	9.0	1.0	8.7	1.0	8.7	1.0	8.7	ns
		nOE to nBn	0.5	15.2	0.5	11.0	0.5	8.7	0.5	6.3	0.5	5.3	ns
$V_{CC(A)} =$	2.3 V to 2.7 V												
t _{pd}	propagation	nAn to nBn	0.5	9.3	0.5	6.4	0.5	5.2	0.5	3.9	0.5	3.3	ns
	delay	nBn to nAn	0.5	5.8	0.5	4.8	0.5	4.3	0.5	3.9	0.5	3.8	ns
t _{dis}	disable time	nOE to nAn	1.1	5.8	1.1	5.8	1.1	5.8	1.1	5.8	1.1	5.8	ns
		nOE to nBn	1.2	11.9	1.2	9.1	1.2	7.6	1.0	5.9	1.0	5.8	ns
t _{en}	enable time	nOE to nAn	0.5	6.0	0.5	6.0	0.5	5.9	0.5	5.8	0.5	5.8	ns
		nOE to nBn	0.5	14.7	0.5	10.6	0.5	8.4	0.5	5.9	0.5	4.8	ns
$V_{CC(A)} =$	3.0 V to 3.6 V												
t _{pd}	propagation	nAn to nBn	0.5	9.1	0.5	6.3	0.5	5.1	0.5	3.8	0.5	3.2	ns
	delay	nBn to nAn	0.5	5.7	0.5	4.3	0.5	3.9	0.5	3.3	0.5	3.2	ns
t _{dis}	disable time	nOE to nAn	0.8	5.5	0.8	5.5	0.8	5.5	0.8	5.5	0.8	5.5	ns
		nOE to nBn	1.2	11.6	1.2	9.0	1.2	7.4	1.0	5.7	0.8	5.5	ns
t _{en}	enable time	nOE to nAn	0.5	4.9	0.5	4.9	0.5	4.8	0.5	4.7	0.5	4.6	ns
		nOE to nBn	1.0	14.5	1.0	10.6	0.5	8.3	0.5	5.7	0.5	4.6	ns

Table 13. Dynamic characteristics for temperature range $-40 \text{ °C to } +125 \text{ °C } \square$

[1] t_{pd} is the same as t_{PLH} and t_{PHL} ; t_{dis} is the same as t_{PLZ} and t_{PHZ} ; t_{en} is the same as t_{PZL} and t_{PZH} .

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11. Waveforms



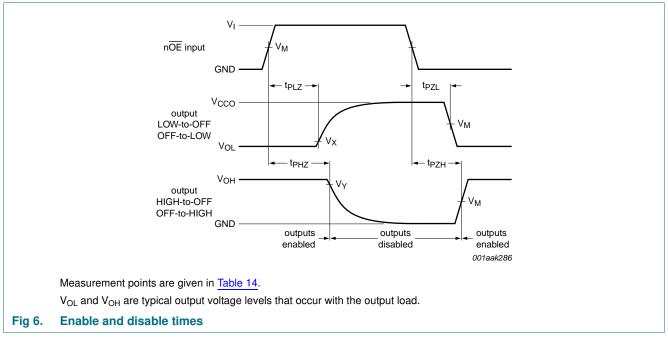


Table 14. Measurement points

Supply voltage	Input ^[1]	Output ^[2]		
$V_{CC(A)}, V_{CC(B)}$	V _M	V _M	V _X	V _Y
0.8 V to 1.6 V	0.5V _{CCI}	0.5V _{CCO}	V _{OL} + 0.1 V	V _{OH} – 0.1 V
1.65 V to 2.7 V	0.5V _{CCI}	0.5V _{CCO}	V _{OL} + 0.15 V	V _{OH} – 0.15 V
3.0 V to 3.6 V	0.5V _{CCI}	0.5V _{CCO}	V _{OL} + 0.3 V	V _{OH} – 0.3 V

[1] V_{CCI} is the supply voltage associated with the data input port.

[2] V_{CCO} is the supply voltage associated with the output port.

74AVC20T245

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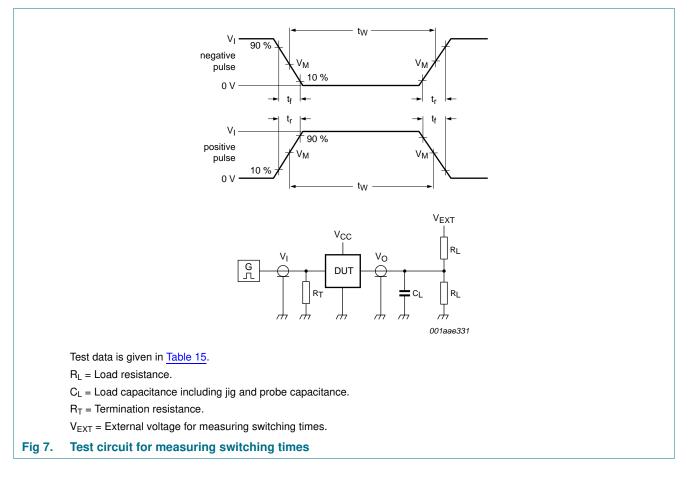


Table 15. Test data

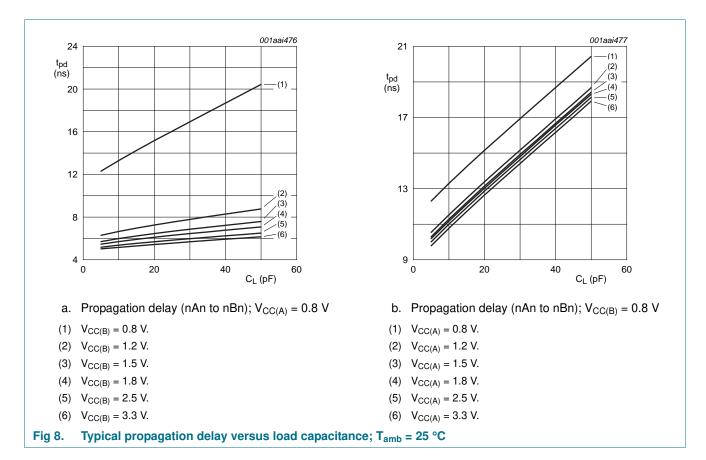
Supply voltage	Input		Load		V _{EXT}		
$V_{CC(A)}, V_{CC(B)}$	V _I [1]	Δt/ΔV[2]	CL	RL	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ} [3]
0.8 V to 1.6 V	V _{CCI}	\leq 1.0 ns/V	15 pF	2 kΩ	open	GND	2V _{CCO}
1.65 V to 2.7 V	V _{CCI}	\leq 1.0 ns/V	15 pF	2 kΩ	open	GND	2V _{CCO}
3.0 V to 3.6 V	V _{CCI}	\leq 1.0 ns/V	15 pF	2 kΩ	open	GND	2V _{CCO}

[1] V_{CCI} is the supply voltage associated with the data input port.

 $[2] \quad dV/dt \geq 1.0 \ V/ns$

[3] V_{CCO} is the supply voltage associated with the output port.

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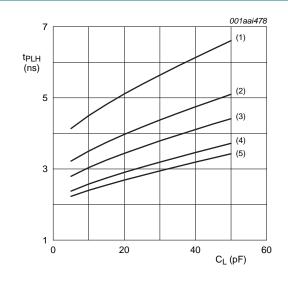


12. Typical propagation delay characteristics

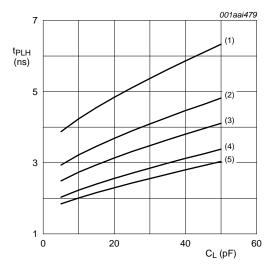
74AVC20T245 Product data sheet

74AVC20T245

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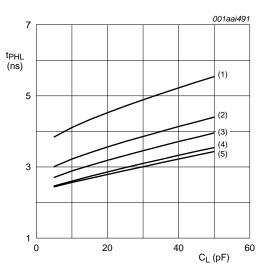


a. LOW to HIGH propagation delay (nAn to nBn); $V_{CC(A)} = 1.2 \text{ V}$

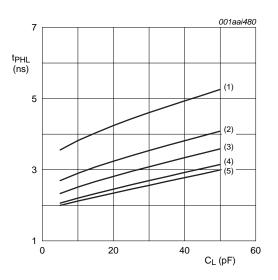


- c. LOW to HIGH propagation delay (nAn to nBn); $V_{CC(A)} = 1.5 \text{ V}$
- (1) $V_{CC(B)} = 1.2$ V.
- (2) $V_{CC(B)} = 1.5$ V.
- (3) $V_{CC(B)} = 1.8$ V.
- (4) $V_{CC(B)} = 2.5$ V.
- (5) $V_{CC(B)} = 3.3$ V.

Fig 9. Typical propagation delay versus load capacitance; T_{amb} = 25 °C



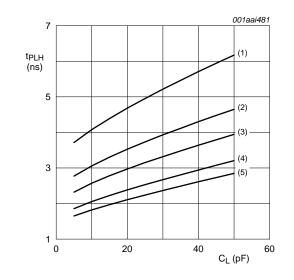
b. HIGH to LOW propagation delay (nAn to nBn); $V_{CC(A)} = 1.2 \text{ V}$



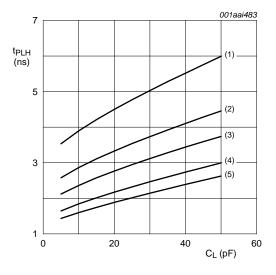
d. HIGH to LOW propagation delay (nAn to nBn); $V_{CC(A)} = 1.5 \text{ V}$

74AVC20T245

20-bit dual supply translating transceiver; 3-state

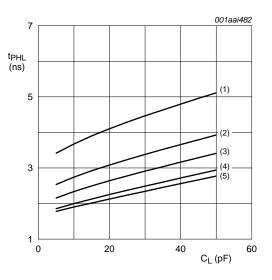


a. LOW to HIGH propagation delay (nAn to nBn); $V_{CC(A)}$ = 1.8 V

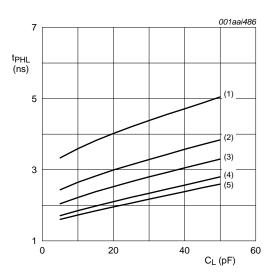


- c. LOW to HIGH propagation delay (nAn to nBn); $V_{CC(A)} = 2.5 \text{ V}$
- (1) $V_{CC(B)} = 1.2$ V.
- (2) $V_{CC(B)} = 1.5$ V.
- (3) $V_{CC(B)} = 1.8$ V.
- (4) $V_{CC(B)} = 2.5 V.$
- (5) $V_{CC(B)} = 3.3$ V.

Fig 10. Typical propagation delay versus load capacitance; T_{amb} = 25 °C



b. HIGH to LOW propagation delay (nAn to nBn); $V_{CC(A)} = 1.8 \text{ V}$



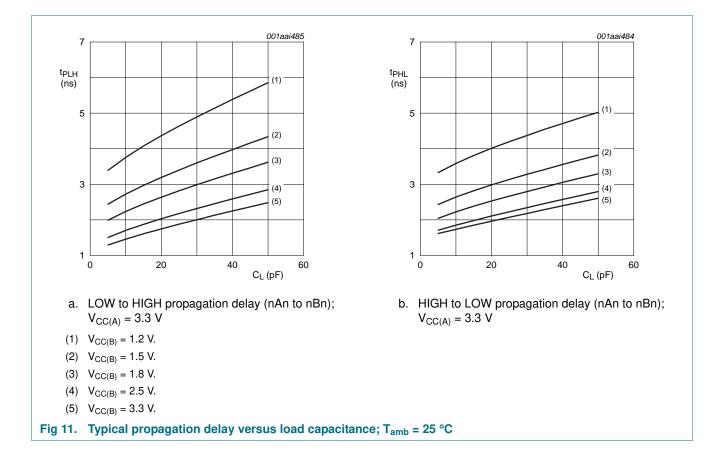
d. HIGH to LOW propagation delay (nAn to nBn); $V_{CC(A)} = 2.5 \text{ V}$

74AVC20T245
Product data sheet

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74AVC20T245

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74AVC20T245

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13. Package outline

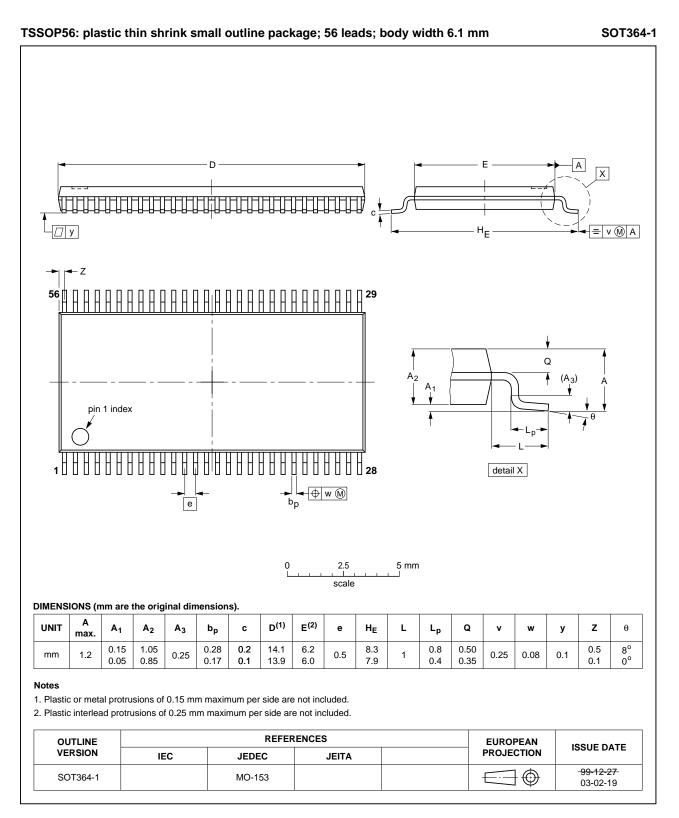


Fig 12. Package outline SOT364-1 (TSSOP56)

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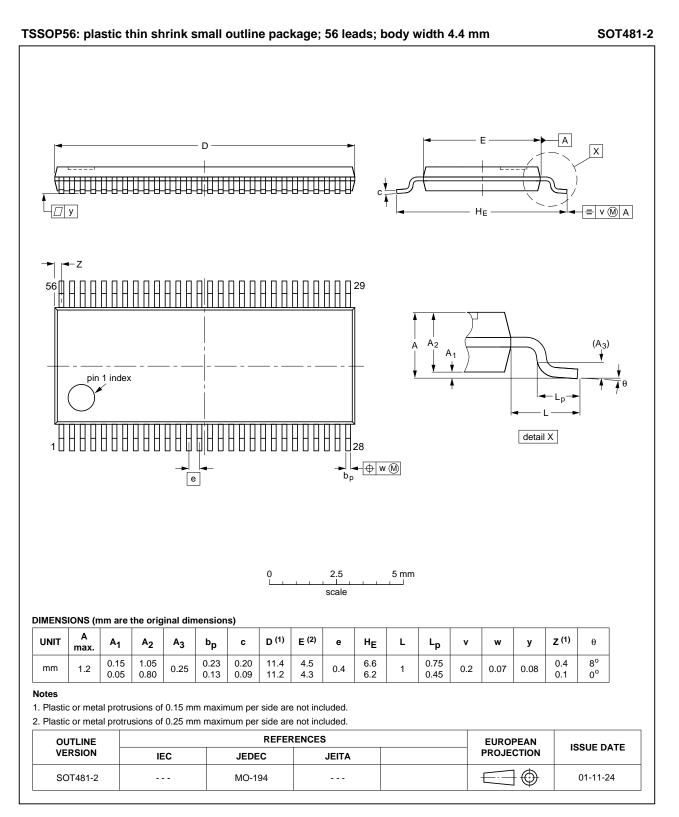
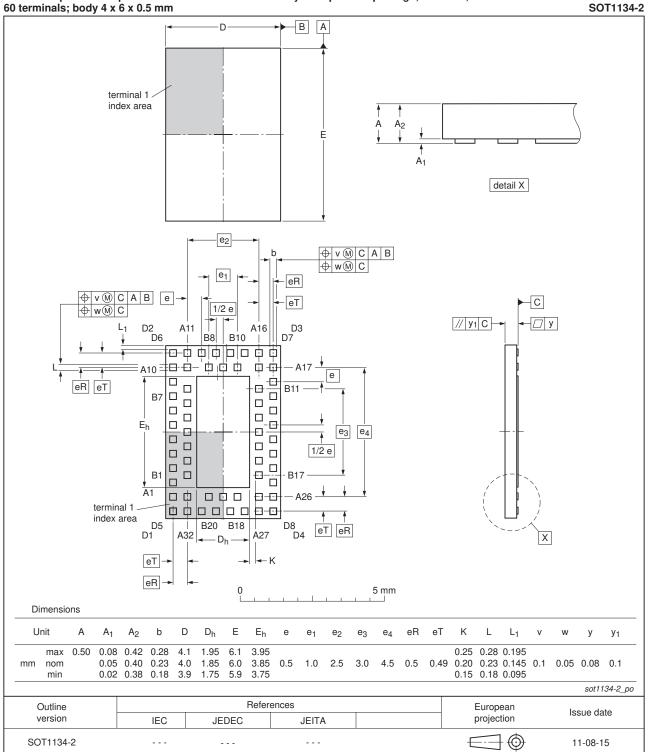


Fig 13. Package outline SOT481-2 (TSSOP56)

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HXQFN60: plastic compatible thermal enhanced extremely thin quad flat package; no leads; 60 terminals; body 4 x 6 x 0.5 mm

Fig 14. Package outline SOT1134-2 (HXQFN60)

74AVC20T245 Product data sheet

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14. Abbreviations

Description
Charmed Davies Medal
Charged Device Model
Device Under Test
ElectroStatic Discharge
Human Body Model
Machine Model

15. Revision history

Table 17. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AVC20T245 v.7	20120308	Product data sheet	-	74AVC20T245 v.6
Modifications:	 For type num 	ber 74AVC20T245BX the sot	code has changed to	SOT1134-2.
74AVC20T245 v.6	20111207	Product data sheet	-	74AVC20T245 v.5
Modifications:	Legal pages	updated.		
74AVC20T245 v.5	20110616	Product data sheet	-	74AVC20T245 v.4
74AVC20T245 v.4	20101124	Product data sheet	-	74AVC20T245 v.3
74AVC20T245 v.3	20100622	Product data sheet	-	74AVC20T245 v.2
74AVC20T245 v.2	20100318	Product data sheet	-	74AVC20T245 v.1
74AVC20T245 v.1	20100111	Product data sheet	-	-

20-bit dual supply translating transceiver; 3-state

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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25 of 27

20-bit dual supply translating transceiver; 3-state

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17. Contact information

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20-bit dual supply translating transceiver; 3-state

18. Contents

1	General description 1
2	Features and benefits 1
3	Ordering information 2
4	Functional diagram 2
5	Pinning information 4
5.1	Pinning 4
5.2	Pin description 6
6	Functional description 6
7	Limiting values 7
8	Recommended operating conditions 7
9	Static characteristics 8
10	Dynamic characteristics 11
11	Waveforms 15
12	Typical propagation delay characteristics 17
13	Package outline 21
14	Abbreviations
15	Revision history 24
16	Legal information
16.1	Data sheet status 25
16.2	Definitions 25
16.3	Disclaimers
16.4	Trademarks 26
17	Contact information 26
18	Contents 27

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